Electronic Patent Application Fee Transmittal							
Application Number:	10	10620346					
Filing Date:	17-Jul-2003						
Title of Invention:	Cc wi	Copper paste, wiring board using the same, and production method of wiring board					
First Named Inventor/Applicant Name:	Hiroshi Sumi						
Filer:	At	Abraham Jacob Rosner/Michelle Delozier					
Attorney Docket Number:	Q76616						
Filed as Large Entity							
Utility Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							
Extension - 1 month with \$0 paid		1251	1	120	120		

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)				
Miscellaneous:								
Request for continued examination	1801	1	790	790				
	Tota	910						